# **Safety Certified, CAS, Surface Mount** X1/Y2 250 VAC, X2 250 VAC (Industrial Grade)

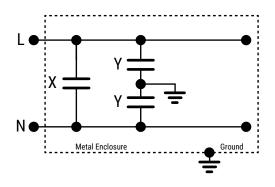


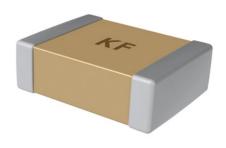
#### **Overview**

KEMET's CAS surface mount safety certified capacitors are specifically designed for interference-suppression AC line filtering applications. When comparing to radial leaded disc capacitors, the CAS surface mount form factor provides engineers the ability to miniaturize their designs with a higher density solution. Having internationally recognized safety certifications, these capacitors are well-suited for applications that require keeping potentially disruptive or damaging line transients and EMI out of susceptible equipment. They are also an ideal solution when needing to suppress line disturbances at the source.

Safety Certified Capacitors are classified as either X and/or Y capacitors. Class X capacitors are primarily used in line-to line (across-the-line) applications. Should the capacitor fail in this application, there is no danger of electric shock to humans but could result in a risk of fire. The Class Y capacitor is primarily used in line-to-ground (line by-pass) applications. In this application, failure of the capacitor could lead to danger of electric shock.

With a working voltage of 250 VAC in line-to-line (Class X) and 250 VAC in line-to-ground (Class Y) applications, these safety capacitors meet the impulse test criteria outlined in IEC Standard 60384. Meeting subclass X1 and Y2 requirements, these devices are certified to withstand impulses up to 5 KV (X1/Y2) and 2.5 KV (X2) respectively.





### **Benefits**

- Safety Certified to IEC 60384-14
- Class X1/Y2, X2
- 250 VAC rating
- 2.5 kV and 5 kV Impulse Voltages
- · Reliable operation up to 125°C
- · Available in COG and X7R Dielectrics
- Case sizes 1808, 1812, 2211, and 2220
- Capacitance offerings ranging from 3.0 pF to 22 nF
- Available capacitance tolerances from ±0.5 pF to ±20%
- RoHS compliant

## **Applications**

Typical applications include:

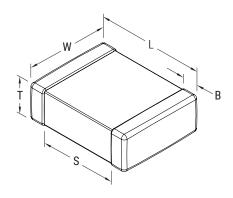
- · Line-to-line (Class X) filtering
- · Line-to-ground (Class Y) filtering
- Antenna coupling
- · Primary and secondary coupling (switching power supplies)
- Line disturbances suppression (motors and motor controls, relays, switching power supplies, and inverters)



### **Ordering Information**

CAS	17	С	471	K	Α	G	F	C	
Type	Case Size (L"x W")	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance	AC Rated Voltage	Dielectric	Subclass Designation	Termination Finish	Packaging (Suffix/C-Spec)
CAS = AC Safety Rated	17 = 1808 18 = 1812 21 = 2220 26 = 2211	С	Two significant digits + number of zeros. Use 9 for 1.0 - 9.9 pF e.g., 2.2 pF = 229	D = ±0.5 pF F = ±1% G = ±2% J = ±5% K = ±10% M = ±20%		G = C0G R = X7R	F = X1/Y2 G = X2	C = 100% Matte Sn	Blank = 7" Reel

# **Dimensions - Millimeters (Inches)**



EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
1808	4520	4.50 (0.177) +0.50 (0.020)/-0.30 (0.012)	2.00 (0.080) ±0.25 (0.010)		0.50 (0.020) ±0.25 (0.010)	> 3.50 (0.138)	
1812	4532	4.50 (0.177) +0.50 (0.020)/-0.30 (0.012)	3.20 (0.126) ±0.40 (0.016)	See Table 2 for Thickness	0.50 (0.020) ±0.25 (0.010)	> 3.50 (0.138)	Solder Reflow Only
2211	5728	5.70 (0.224) ±0.40 (0.016)	2.80 (0.110) ±0.30 (0.012)	Tillokiicss	0.60 (0.024) ±0.30 (0.012)	> 4.00 (0.157)	Omy
2220	5750	5.70 (0.224) ±0.40 (0.016)	5.00 (0.197) ±0.40 (0.016)		0.60 (0.024) ±0.30 (0.012)	> 4.00 (0.157)	

## Qualification

Safety Standard	Specification	Subclass	Working Voltage	Certificate No.	
TUV	IEC 60384-14	X1/Y2	250 VAC	<u>R 50441101</u>	
100	IEC 00364-14	X2	250 VAC	<u>R 50441118</u>	
UL	UL 60384-14 and	X1/Y2	250 VAC	F256200	
CAN/CSA	E60384-14	X2	250 VAC	<u>E356389</u>	

These devices are TUV/ENEC recognized for antenna coupling and AC line-to-line (Class X) and line-to-ground (Class Y) applications per IEC60384–14.



## **Environmental Compliance**

These devices are RoHS compliant. They meet all requirements set forth by EU RoHS directives.



Table 1A - Product Ordering Codes & Ratings - X1/Y2 COG

				Case	Size			1808	1812	2211	
Capacitance	Capacitance		Class					X1/Y2			
Capacitance	Code		Pea	k Impu	lse Volt	tage			5,000 V		
			Capa	acitanc	e Toler	ance		See Table 2	ability and Chip Th for Chip Thickness	ickness Codes Dimensions	
3.0 pF 3.3 pF 3.9 pF	309 339 399	D D D						AF AF		014	
4.0 pF 4.7 pF	409 479	D						AF AF		CK CK	
5.0 pF 5.6 pF 6.0 pF 6.8 pF 7.0 pF	509 569 609 689 709	D D D D						AF AF AF AF		CK CK CK CK CK	
8.0 pF 8.2 pF 10 pF 12 pF 15 pF	809 829 100 120 150	D D	F F F	G G G	J J	K K K	M M M	AF AF AF AF AF	BD BD BD	CK CK CK CK CK	
18 pF 22 pF 27 pF 33 pF 39 pF	180 220 270 220 390		F F F F	G G G G	J J J	K K K K	M M M M	AF AF AF AF AG	BD BD BD BD BD	CK CK CK CK	
47 pF 56 pF 68 pF 82 pF 100 pF	470 560 680 820 101		F F F F	G G G G	J J J	K K K K	M M M M	AG AG AG AG AK	BD BD BD BD BD	CK CK CK CK	
120 pF 150 pF 160 pF 180 pF 220 pF	121 151 161 181 221		F F F F	G G G G	J	K K K K	M M M M	AK AK AK AK AK	BD BD BD BD BK	CM CM CM CM	
270 pF 330 pF 390 pF 470 pF 560 pF	271 331 391 471 561		F F F F	G G G G	J J J	K K K K	M M M M	AK	BK BK BK BK	CM CM CM CM	
680 pF 720 pF 820 pF 1,000 pF	681 721 821 102		F F F F	G G G	J J J	K K K	M M M M			CM	



# Table 1B - Product Ordering Codes & Ratings - X1/Y2 X7R

		(	Case Siz	ze .	1808	1812	2211	2220
Oanasitanas	Capacitance		Class			X1,	/Y2	
Capacitance	Code	Peak	Impulse \	/oltage		5,0	00V	
		Capacitance Tolerance					d Chip Thickness Co Thickness Dimensio	
100 pF	101	J	K	М	AG			
120 pF	121	ļļ	K	M	AG	D.C.	00	
150 pF 180 pF	151 181	J	K K	M M	AG AG	BG BG	CG CG	DK
220 pF	221	J	K	M	AG	BG	CG	DK DK
270 pF	271	Ĵ	Ř	M	AK	BG	ČĞ	DK
330 pF	331	J	K	M	AK	BG	CG	DK
390 pF	391	J	K	M	AK	BG	CG	DK
470 pF	471	ļ	K	M	AK	BG	CK	DK
560 pF	561	J	K	M M	AK	BG BK	CK CK	DK DK
680 pF 820 pF	681 821	J	K	M	AK AK	BK BK	CK CK	DK DK
1,000 pF	102	J	K	M	AK	BM	CM	DK
1,200 pF	122	Ĵ	Ř	M	7.11	5	l čm	DM
1,500 pF	152	Ĵ	K	M			CM	DM
1,800 pF	182	J	K	M			CM	DM
2,200 pF	222	J	K	M			CM	DM
2,700 pF	272	J	K	M				DM
3,300 pF 3,900 pF	332 392	J	K K	M M				DM DM
4,700 pF	472	J	K	M				DM



## Table 1C - Product Ordering Codes & Ratings - X2 COG

				Case	Size			1808	1812	
	Capacitance	Class						X2		
Capacitance	Code		Pea	k Impu	lse Vol	tage		2,5	00V	
			Capa	acitanc	e Toler	ance		See Table 2 for Chip 1	d Chip Thickness Codes Thickness Dimensions	
3.0 pF 4.0 pF 5.0 pF 6.0 pF 7.0 pF	309 409 509 609 709	D D D						AF AF AF AF AF		
8.0 pF 9.0 pF 10 pF 12 pF 15 pF	809 909 100 120 150	D D	F F F	G G G	J J	K K K	M M M	AF AF AF AF AF	BD BD BD	
22 pF 27 pF 33 pF 39 pF 47 pF	220 270 330 390 470		F F F F	G G G G	J J J	K K K K	M M M M	AF AF AF AG AG	BD BD BD BD BD	
56 pF 68 pF 82 pF 100 pF 120 pF	560 680 820 101 121		F F F F	G G G G	J J J	K K K K	M M M M	AG AG AG AK AK	BD BD BD BD BD	
150 pF 180 pF 220 pF 270 pF 330 pF	151 181 221 271 331		F F F F	G G G G	J J J	K K K K	M M M M	AK AK AK AK AK	BD BD BD BF BF	
390 pF 470 pF 560 pF 680 pF 820 pF 1,000 pF	391 471 561 681 821 102		F F F	G G G G	J	K K K K	M M M M M	AK AK AK AK AK AK	BF BG BK BK BM BM	



## Table 1D - Product Ordering Codes & Ratings - X2 X7R

							•		
		C	Case Siz	e	1808	1812	2220		
0	Capacitance		Class			X2			
Capacitance	Code	Peak I	mpulse V	oltage	2,500V				
		Capaci	tance Tol	erance		ability and Chip Thi for Chip Thickness			
150 pF	151	J	K	М	AG				
180 pF	181	J	K	M	AG				
220 pF	221	J	K	M	AG	DO.			
270 pF	271 301	J	K K	M M	AG AG	BG BG			
300 pF 330 pF	331	J	K	M	AG AG	BG			
390 pF	391	J	K	M	AG AG	BG BG			
470 pF	471	J	K	M	AG AG	BG			
560 pF	561	Ĵ	K	M	AG	BG			
680 pF	681	Ĵ	K	M	AG	BG			
720 pF	721	Ĵ	K	M	AG	BG			
820 pF	821	Ĵ	K	M	AG	BG			
1,000 pF	102	Ĵ	K	M	AK	BG			
1,200 pF	122	Ĵ	K	М	AK	BG			
1,500 pF	152	J	K	M	AK	BK			
1,800 pF	182	J	K	М	AK	BK			
2,200 pF	222	J	K	М	AK	BM			
2,700 pF	272	J	K	M		BM			
3,300 pF	332	J	K	M		BM			
3,900 pF	392	J	K	M		BM			
4,700 pF	472	J	K	M		BM			
5,600 pF	562	J	K	M		ВМ	DM		
0.010 uF	103 123	J	K	M M			DM DM		
0.012 uF 0.015 uF	153	J	K K	M			DM DM		
0.015 uF 0.018 uF	183	J	K	M			DM DM		
0.018 uF 0.022 uF	223	J	K	M			DU		



#### Table 2 - Chip Thickness/Tape & Reel Packaging Quantities

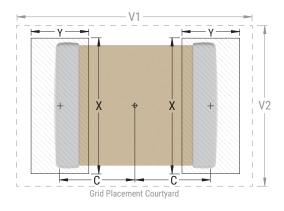
Case Size	Thickness Code	Thickness Range (mm)	Plastic Quantity
	AF	1.40±0.15	2,000
1808	AG	1.60±0.20	2,000
	AK	2.00±0.20	1,000
	BD	1.25±0.10	1,000
	BF	1.40±0.15	1,000
1812	BG	1.60±0.20	1,000
	BK	2.00±0.20	1,000
	BM	2.50±0.30	500
	CG	1.60±0.20	1,000
2211	CK	2.00±0.20	1,000
2211	CM	2.50±0.30	500
	CU	2.80±0.30	500
	DK	2.00±0.20	1,000
2220	DM	2.50±0.30	500
	DU	2.80±0.30	500

Table 3 - Chip Capacitor Land Pattern Design Recommendations per IPC-7351

EIA Size Code	Metric Size Code	Density Level A: Maximum (Most) Land Protrusion (mm)				ı	Density Level B: Median (Nominal) Land Protrusion (mm)				Density Level C: Minimum (Least) Land Protrusion (mm)					
Oouc	Jouc	С	Y	X	V1	V2	C	Y	X	V1	V2	С	Y	X	V1	V2
1808	4520	2.30	1.75	2.30	7.40	3.30	2.20	1.55	2.20	6.50	2.70	2.10	1.35	2.10	5.80	2.40
1812	4532	2.15	1.60	3.60	6.90	4.60	2.05	1.40	3.50	6.00	4.00	1.95	1.20	3.40	5.30	3.70
2211	5728	2.81	1.70	3.21	7.30	3.40	2.76	1.60	3.11	7.10	3.50	2.71	1.50	3.01	6.90	3.30
2220	5650	2.75	1.70	5.50	8.20	6.50	2.65	1.50	5.40	7.30	5.90	2.55	1.30	5.30	6.60	5.60

**Density Level A:** For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes.

**Density Level B:** For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC-7351).



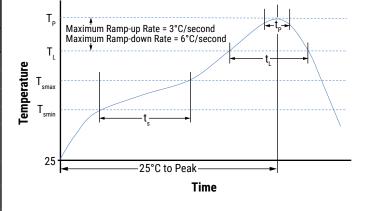


### **Soldering Process**

#### **Recommended Reflow Soldering Profile**

KEMET's family of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

Profile Feature	Termination Finish		
Trome readure	100% Matte Sn		
Preheat/Soak			
Temperature Minimum (T <sub>smin</sub> )	150°C		
Temperature Maximum (T <sub>Smax</sub> )	200°C		
Time $(t_s)$ from $T_{smin}$ to $T_{smax}$	60 - 120 seconds		
Ramp-Up Rate (T <sub>L</sub> to T <sub>p</sub> )	3°C/second maximum		
Liquidous Temperature (T <sub>L</sub> )	217°C		
Time Above Liquidous (t <sub>L</sub> )	60 - 150 seconds		
Peak Temperature (T <sub>p</sub> )	260°C		
Time Within 5°C of Maximum Peak Temperature (t <sub>p</sub> )	30 seconds maximum		
Ramp-Down Rate (T <sub>P</sub> to T <sub>L</sub> )	6°C/second maximum		
Time 25°C to Peak Temperature	8 minutes maximum		



Note: All temperatures refer to the center of the package, measured on the capacitor body surface that is facing up during assembly reflow.



## Table 4 - Performance & Reliability: Test Methods and Conditions

Item	Standard	Specification	Requirements					
Visual examination and Dimensions	IEC 60384-1 4.1		No remarkable defect. Dimensions to conform to individual specification sheet.					
Capacitance	IEC 60384-1 4.2.2		Capacitance is within specified tolerance					
Dissipation Factor (DF) or Q	IEC 60384-1 4.2.3	Class I: COG Capacitance ≤ 1,000 pF, 1.0 ±0.2 V <sub>rms</sub> , 1 MHz ±10% Capacitance > 1,000 pF, 1.0 ±0.2 V <sub>rms</sub> , 1 KHz ±10% Class II: (X7R) 1.0 ±0.2 V <sub>rms</sub> , 1 kHz ±10%   Dielectric Temperature Range	Dielectric         Q/DF         Requirement           COG         Q ≥ 1,000         Cap ≥ 30 pF           Q ≥ 400 +20C¹         Cap < 30 pF					
Temperature Coefficient	IEC 60384-21/22 4.6	C0G	COG ±30 ppm/°C  X7R ±15%					
Dielectric Strength	IEC 60384-14 4.2.1	X Capacitor: 1,075 VDC (4.3 $\rm U_R$ ) Y Capacitor: 1,500 VAC Duration = 60 Seconds Charge current shall not exceed 50 mA Voltage shall be raised from zero to test voltage at a rate not exceeding 150 $\rm V_{rms}/second$	No evidence of flashover					
Insulation Resistance	IEC 60384-21/22 4.5.3	500 V for 60 seconds <50 mA charging current	Dielectric         Insulation Resistance           COG         1,000 megohm microfarads or 100 GΩ           Whichever is smaller         500 megohm microfarads or 10 GΩ           Whichever is smaller         Whichever is smaller					
Solderability	IEC 60384-21/22 4.10	Solder temperature: 245±5°C Dipping time: 2±0.2 seconds	75% minimum coverage of all metalized area					
	JE0 60004 44	Solder temperature: 260 ±5°C	No visible damage.					
Resistance to	IEC 60384-14 4.4	Dipping time: 10 ±1 second Preheat 120°C - 150°C for 1 minute before	Dielectric IR Capacitance Change					
Solder Heat	IEC 60384-21/22 4.9	immersing the capacitor in a eutectic solder. For X7R capacitors, measurements can be made after keeping at room temperature for 24 ±2 hours	COG ≥ 1 GΩ Within ±2.5% or ±0.25 pF, whichever is larger. ±7.5%					
Temperature Cycling	IEC 60384-21/22 4.11	Five cycles           Step         Temp. (°C)         Time (min.)           1         -55°C         30 ±3           2         25°C         3           3         125°C         30 ±3           4         25°C         3           Measurements to be made after keeping at room temperature for 24 ±2 hours	Dielectric IR Capacitance Change  COG Initial Within ±2.5% or ±0.25 pF, whichever is larger.  ±7.5%					
Humidity (Damp Heat) Steady State	IEC 60384-14 4.12	Test temperature: 40±2°C Humidity: 90 – 95% RH Test time: 500 +24/-0 hours Applied Voltage: 250 VAC Measurement to be made after keeping at room temperature for 24±2 hours	Dielectric     IR     Capacitance Change       C0G     25 megohm microfarads or 1 GΩ     Within ±3.0% or ±2 pF, whichever is larger.       X7R     Whichever is smaller     ±15%					



## Table 4 - Performance & Reliability: Test Methods and Conditions cont.

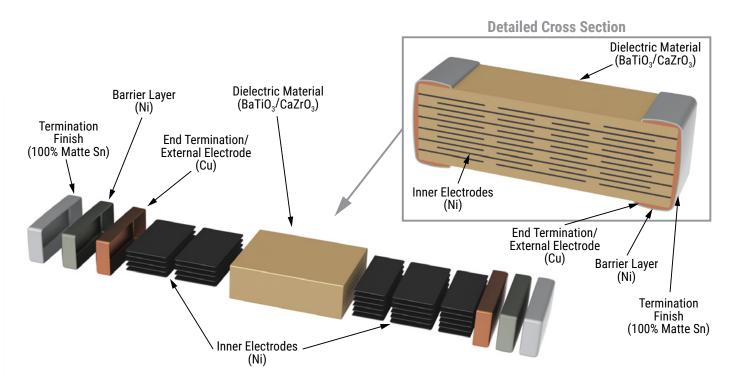
Item	Standard	Specification	Requirements
Passive Flammability	IEC 60384-14 4.17 IEC 60384-1 4.38	Volume sample: 21.56 mm³ Flame exposure time: 5 seconds maximum Category of flammability: C	No evidence of burning
Active Flammability	IEC 60384-21/22 4.18	The capacitors applied V <sub>R</sub> (250 VAC). Then each sample shall be subjected to 20 discharges from a tank capacitor, charge to a voltage that, when discharged, Ui 2,500 V for X2, Ui 5,000 V for X1/Y2 across the capacitor under test. The interval between successive discharges shall be 5 seconds.	The cheese cloth shall not burn with the flame.
Endurance	IEC 60384-14 4.14	Impulse Voltage: Each capacitor shall be subjected to a Vp = 5.0 KV (X1/Y2 Class Impulse 5 KV) impulse for three times before applied to endurance test. Test Temp: $125 \pm 3^{\circ}$ C Test time: $1,000 + 48/-0$ hours Applied Voltage:  X capacitor: $1.25 \text{ V}_R$ (312.5 VAC) Y capacitor: $1.70 \text{ V}_R$ (425 VAC) Once every hour the voltage shall be increased to 1,000 V ms for 0.1 second Measurement to be made after keeping at room	Appearance: No mechanical damage.    Dielectric   IR
Resistance to Flexure of Substrate	IEC 60384-21/22 4.8	Capacitors mounted on substrate. The board shall be bent 1 mm with rate of 1 mm/second  R = 230  A 550  R = 230	Dielectric Capacitance Change  COG Within ±3.0% or ±2 pF, whichever is larger.  X7R ±12.5%
Robustness of terminations (Adhesive Strength of Termination)	IEC 60384-21/22 4.15 IEC 60384-1 4.13	Capacitors mounted on a substrate. A force of 10 N applied perpendicular to the place of substrate and parallel the line joining the center of terminations for 10 ±1 second.  10N PC Board Capacitor	No remarkable damage or removal of the terminations
Vibration	IEC 60384-14 4.17	<ul> <li>Vibration frequency: 10~55 Hz/minute</li> <li>Total amplitude: 1.5 mm</li> <li>Repeat the conditions for 2 hours each in 3 perpendicular directions</li> </ul>	No remarkable damage     Capacitance change and Q/D.F.: To meet initial specification
Impulse Voltage	IEC 60384-14 4.13	X1: 4.0 KV, X2: 2.5 KV Y2: 5.0 KV Number of impulses: 24 maximum	There shall be no permanent breakdown or flashover.



#### **Storage & Handling**

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature— reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. In addition, temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 6 months of receipt.

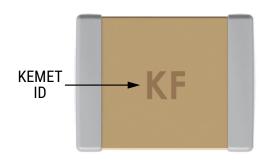
#### Construction

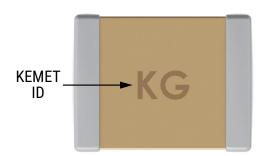




# Marking

<b>Subclass Designation</b>	Marking	
X1/Y2	KF	
X2	KG	







#### **Tape & Reel Packaging Information**

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12, 16 and 24 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

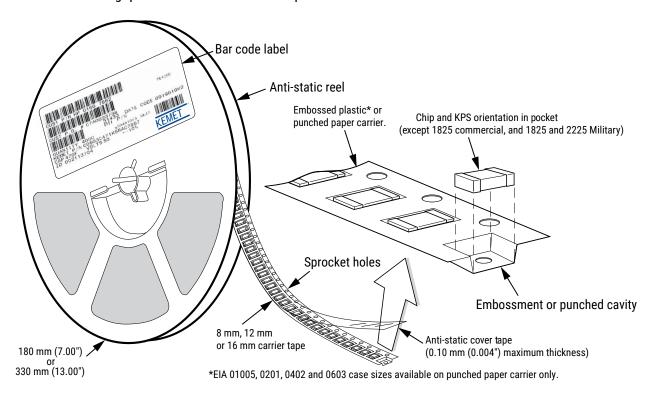


Table 5 - Carrier Tape Configuration, Embossed Plastic (mm)

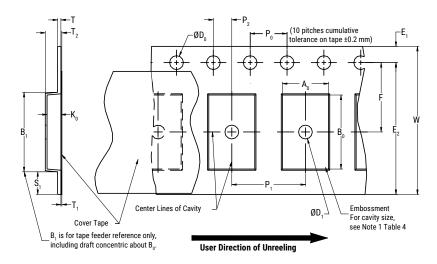
		Embossed Plastic	
EIA Case Size	Tape Size (W)*	7" Reel	
		Pitch (P <sub>1</sub> )*	
1808	12	4	
≥ 1812	12	8	

<sup>\*</sup>Refer to Figure 1 for W and  $P_1$  carrier tape reference locations.

<sup>\*</sup>Refer to Tables 4 and 5 for tolerance specifications.



### Figure 1 – Embossed (Plastic) Carrier Tape Dimensions



### **Table 6 - Embossed (Plastic) Carrier Tape Dimensions**

Metric will govern

	Constant Dimensions — Millimeters (Inches)								
Tape Size	D <sub>0</sub>	D <sub>1</sub> Minimum Note 1	E <sub>1</sub>	$P_0$	P <sub>2</sub>	R Reference Note 2	S <sub>1</sub> Minimum Note 3	T Maximum	T1 Maximum
12 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.5 (0.059)	1.75±0.10 (0.069±0.004)	4.0±0.10 (0.157±0.004)	2.0±0.05 (0.079±0.002)	30 (1.181)	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)
Variable Dimensions — Millimeters (Inches)									
Tape Size	Pitch	B <sub>1</sub> Maximum Note 4	${\sf E_2^2}$ Minimum	F	T <sub>2</sub> Maximum	W Maximum		$A_0, B_0$ , and $K_0$	
12 mm	Single (4 mm) and Double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5±0.05 (0.217±0.002)	4.6 (0.181)	12.3 (0.484)		Note 5	

<sup>1.</sup> The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.

- 2. The tape with or without components shall pass around R without damage (see Figure 6).
- 3. If S<sub>1</sub> < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Document 481 paragraph 4.3 (b)).
- 4.  $B_1$  dimension is a reference dimension for tape feeder clearance only.
- 5. The cavity defined by  $A_{\alpha}$ ,  $B_{\alpha}$  and  $K_{\alpha}$  shall surround the component with sufficient clearance that:
- (a) the component does not protrude above the top surface of the carrier tape.
- (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
- (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3).
- (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 mm and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4)
- (e) For KPS Series product, A0 and B0 are measured on a plane 0.3 mm above the bottom of the pocket.
- (f) see Addendum in EIA Document 481 for standards relating to more precise taping requirements.



### **Packaging Information Performance Notes**

1. Cover Tape Break Force: 1.0 kg minimum.

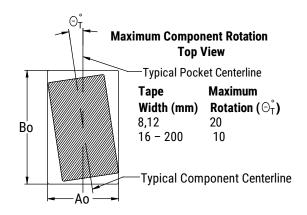
2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

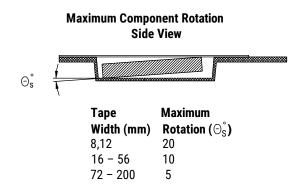
Tape Width	Peel Strength		
8 mm	0.1 to 1.0 Newton (10 to 100 gf)		
12 and 16 mm	0.1 to 1.3 Newton (10 to 130 gf)		
24 mm	0.1 to 1.6 Newton (10 to 160 gf)		

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300±10 mm/minute.

**3. Labeling:** Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624*.

### Figure 2 - Maximum Component Rotation





### Figure 3 - Maximum Lateral Movement

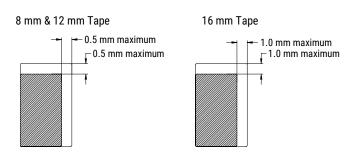
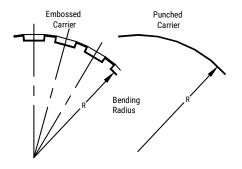
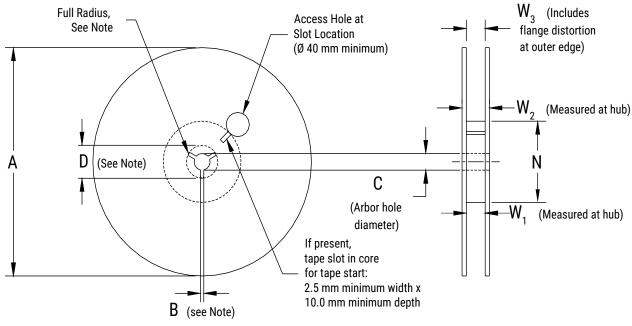


Figure 4 - Bending Radius





**Figure 5 - Reel Dimensions** 



Note: Drive spokes optional; if used, dimensions B and D shall apply.

#### **Table 7 - Reel Dimensions**

Metric will govern

Constant Dimensions — Millimeters (Inches)						
Tape Size	A	B Minimum	С	D Minimum		
12 mm	178±0.20 (7.008±0.008) or 330±0.20 (13.000±0.008)	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)		
Variable Dimensions — Millimeters (Inches)						
Tape Size	N Minimum See Note 2, Tables 2-3	W <sub>1</sub>	W <sub>2</sub> Maximum	W <sub>3</sub>		
12 mm 50 (1.969)		12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	Shall accommodate tape width without interference		



#### **KEMET Electronics Corporation Sales Offices**

For a complete list of our global sales offices, please visit www.kemet.com/sales.

#### **Disclaimer**

All product specifications, statements, information and data (collectively, the "Information") in this datasheet are subject to change. The customer is responsible for checking and verifying the extent to which the Information contained in this publication is applicable to an order at the time the order is placed. All Information given herein is believed to be accurate and reliable, but it is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on KEMET Electronics Corporation's ("KEMET") knowledge of typical operating conditions for such applications, but are not intended to constitute – and KEMET specifically disclaims – any warranty concerning suitability for a specific customer application or use. The Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by KEMET with reference to the use of KEMET's products is given gratis, and KEMET assumes no obligation or liability for the advice given or results obtained.

Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicated or that other measures may not be required.

### **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

#### **KEMET**:

```
CAS17C102KARFC CAS17C152KARGC CAS21C472KARFC CAS26C220KAGFC CAS26C221KARFC
CAS26C681KAGFC CAS17C100JAGGC CAS17C102KARGC CAS17C330JAGFC CAS17C681KARFC
CAS17C681KARGC CAS18C102KARFC CAS18C472KARGC CAS26C102KARFC CAS26C222KARFC
CAS21C561KARFC CAS17C561GAGGC CAS17C471KAGGC CAS26C709DAGFC CAS17C151FAGGC
CAS18C221MAGGC CAS18C471MARFC CAS18C182JARGC CAS17C151FAGFC CAS17C271MARFC
CAS17C161JAGFC CAS26C221JAGFC CAS18C330JAGGC CAS26C330KAGFC CAS18C151JAGGC
CAS18C680JAGFC CAS26C270JAGFC CAS26C151KAGFC CAS18C100GAGFC CAS18C681KAGGC
CAS18C182MARGC CAS17C681GAGGC CAS17C120GAGFC CAS17C470FAGFC CAS18C471GAGGC
CAS18C271MAGGC CAS17C151GAGFC CAS18C221MARFC CAS18C821KARFC CAS18C151KAGFC
CAS26C120MAGFC CAS26C331FAGFC CAS21C223JARGC CAS18C120KAGFC CAS18C391FAGFC
CAS21C221JARFC CAS18C820JAGGC CAS17C182KARGC CAS21C123KARGC CAS17C331MARGC
CAS18C470KAGGC CAS26C181FAGFC CAS21C392MARFC CAS26C101KAGFC CAS26C471KARFC
CAS17C270FAGGC CAS17C151KARGC CAS17C390KAGFC CAS17C821KARFC CAS17C221GAGGC
CAS17C180MAGFC CAS17C680FAGFC CAS18C122JARGC CAS26C100JAGFC CAS17C150FAGGC
CAS18C270JAGGC CAS17C270JAGFC CAS17C471JARGC CAS18C390GAGGC CAS17C390MAGFC
CAS17C561KARGC CAS17C220GAGGC CAS18C150MAGFC CAS18C561JAGGC CAS18C122MARGC
CAS18C102MARGC CAS18C100MAGGC CAS26C409DAGFC CAS26C151GAGFC CAS17C221GAGFC
CAS18C221GAGGC CAS17C100GAGGC CAS18C391GAGFC CAS17C331MARFC CAS17C390JAGFC
CAS21C821JARFC CAS17C182MARGC CAS17C181FAGGC CAS18C330GAGFC CAS18C161KAGFC
CAS17C909DAGGC CAS17C391MAGGC CAS18C821KARGC CAS17C390FAGGC CAS18C120FAGGC
```